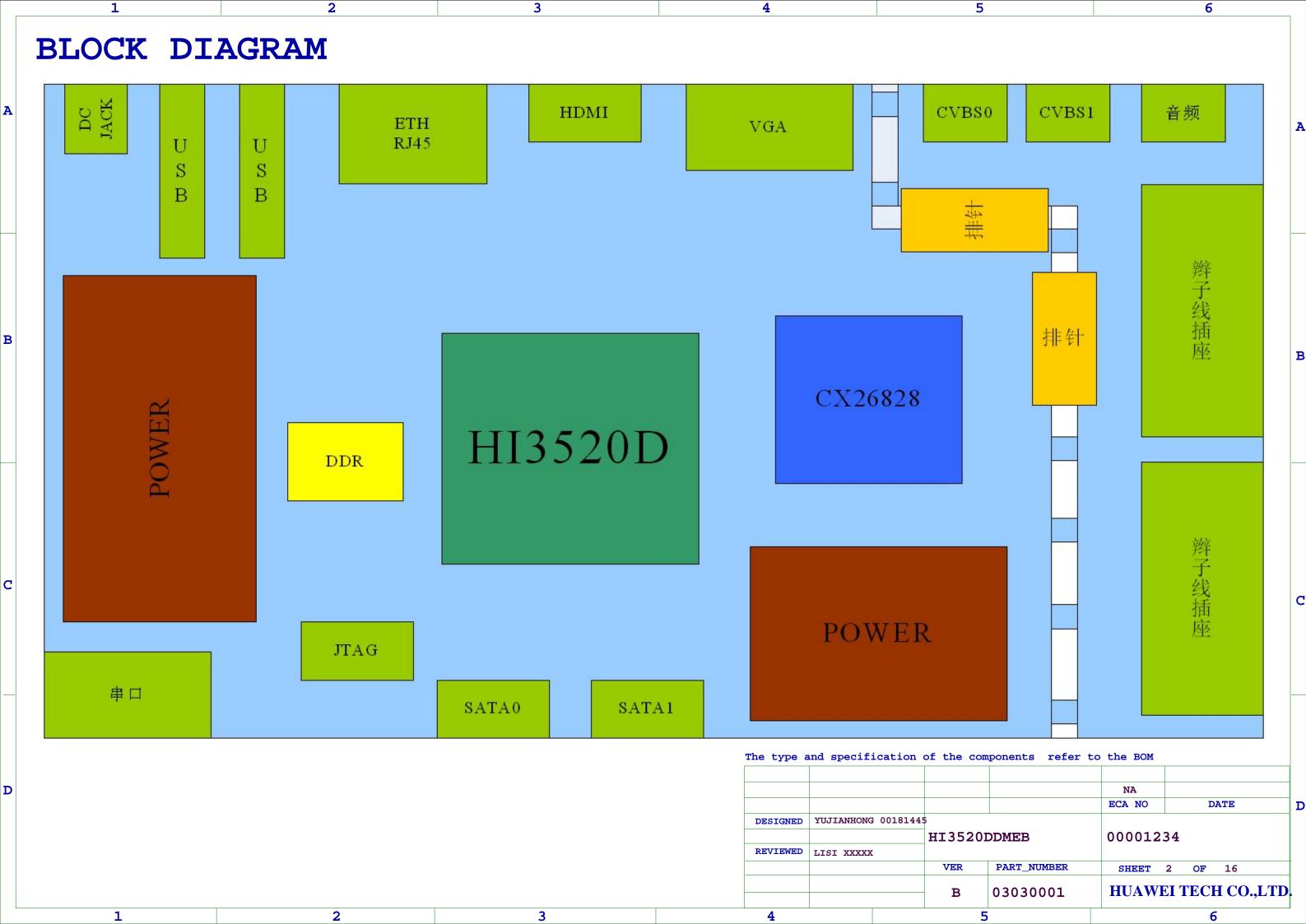
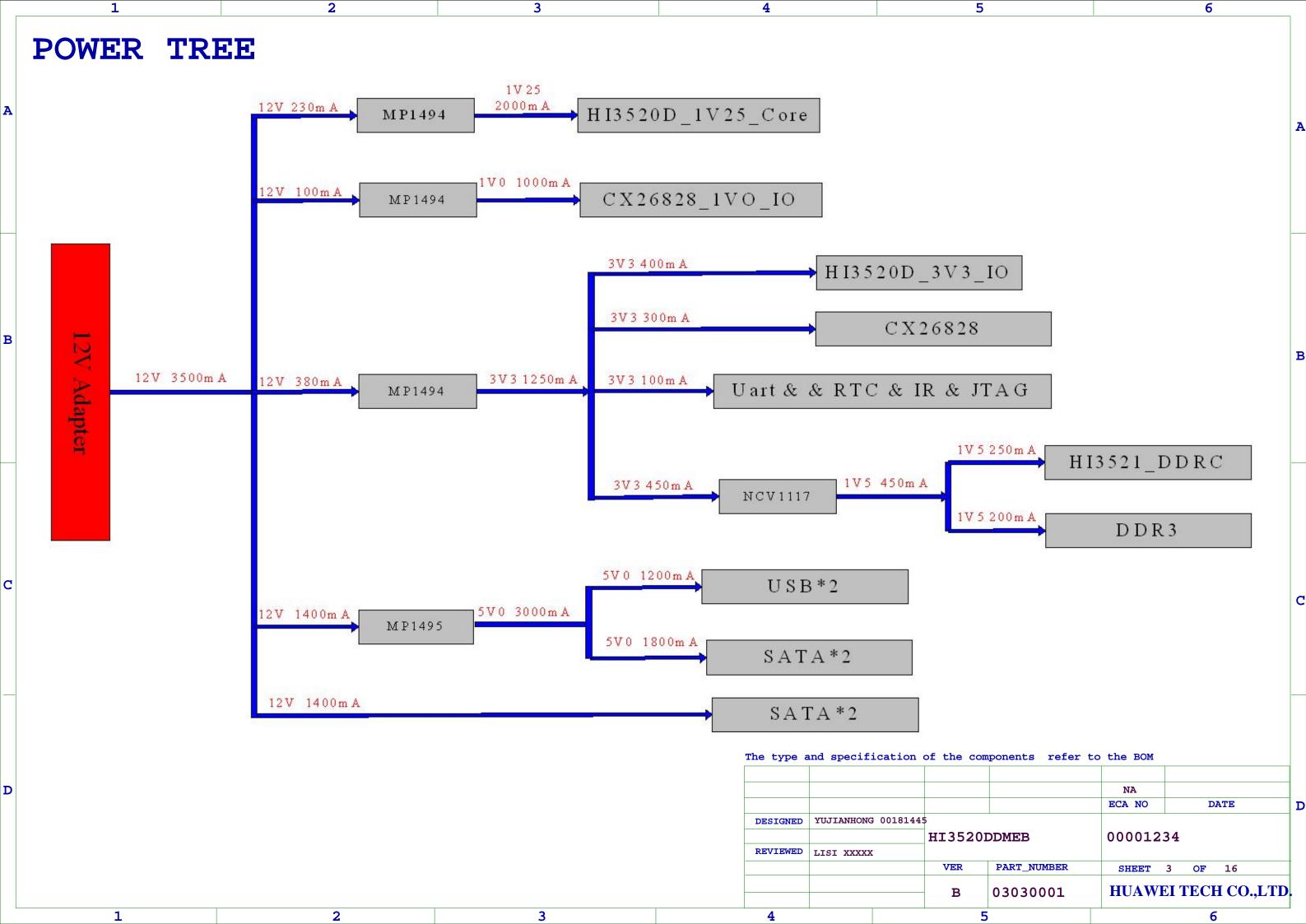
1.Hi3520DDMEB VER.B 2.BLOCK DIAGRAM 3.POWER TREE 4. CHANGE LIST 5. POWER SUPPLY1 6.POWER SUPPLY2 7.Hi3520D POWER\_GND Hi3520DDMEB Ver.B 8.Hi3520D DDR3 9.Hi3520D SYS\_RST\_JTAG 10.JTAG & RS232 & RS485 & ETH & RTC 11.Interface 12.Display 13.HDMI 14.VI 15.CX26828 16.Backboard 17.Backboard The type and specification of the components refer to the BOM ECA NO DATE D DESIGNED YUJIANHONG 00181445 HI3520DDMEB 00001234 REVIEWED LISI XXXXX VER PART\_NUMBER **OF** 17 **HUAWEI TECH CO.,LTD.** 03030001

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5 1 6 Change list 2013.01.01 Ver.A schematic. 2013.04.21 Ver.B schematic. 1) Updata VDAC RETX value. Change R59 from 200R to 191R, change R156 from NC to 3.01K 2) Change C257 from 100nF to 1uF 3) Change R179 from 158R to 750R. Change R89 from 750R to 160R 4) Updata HDMI REXT value. Change R188 from 6.8K to 11K. Change R134 from 51K to 39K 5)Add LPF to the VGA\_RGB output(NC in the SCH & PCB ) 6)Add JTAG\_SEL select 7) Add External RTC circuit. This circuit has not been modified in the PCB The type and specification of the components refer to the BOM NA ECA NO DATE YUJIANHONG 00181445 DESIGNED HI3520DDMEB 00001234 REVIEWED | LISI XXXXX VER PART\_NUMBER SHEET 4 **OF** 17 03030001 **HUAWEI TECH CO.,LTD.** В 5

